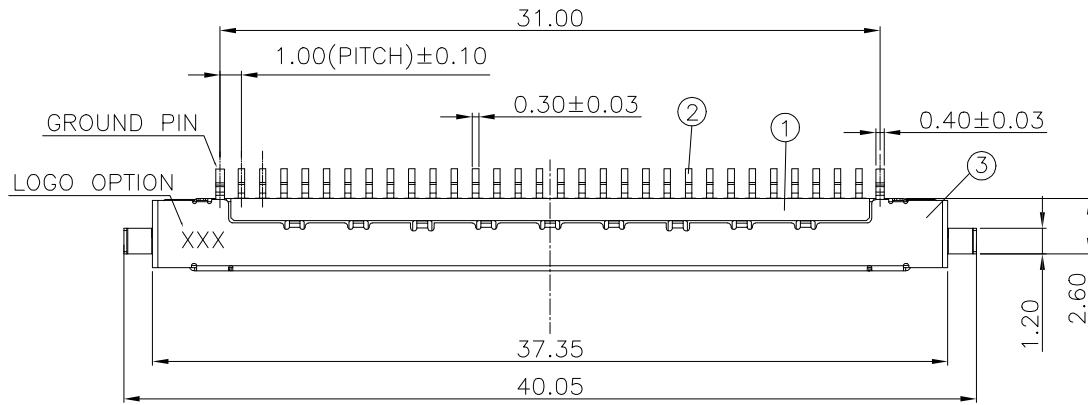
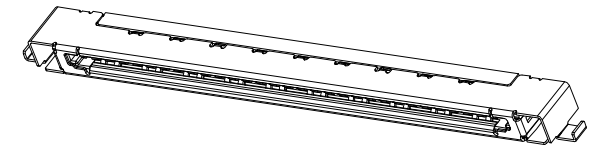
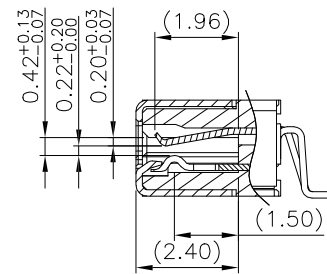
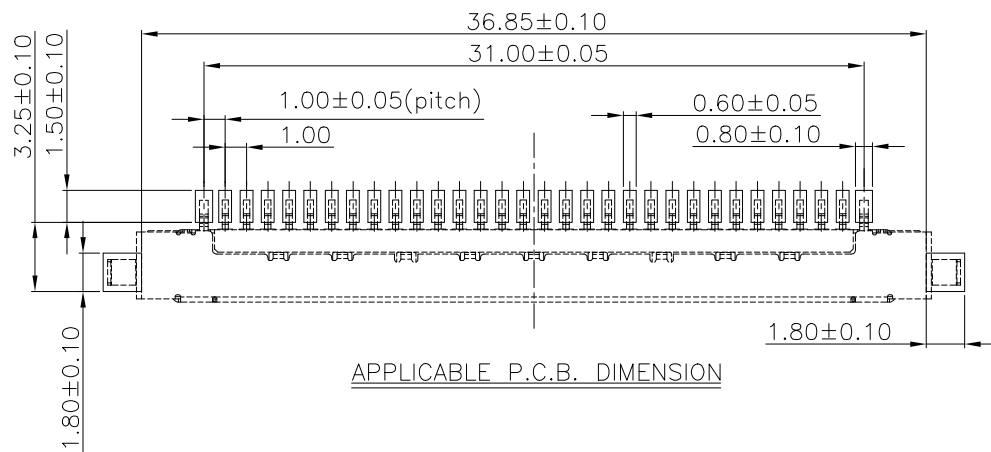
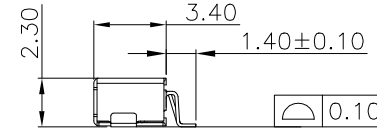
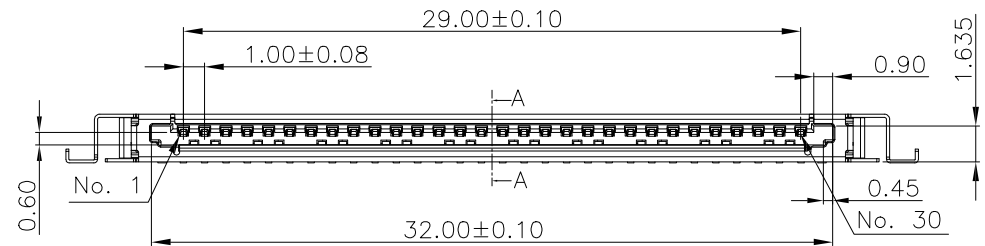



REV	ECN NO.	LOCAS.	DESCRIPTION	DATE	DESIGN
A			NEW DRAWING		



- NOTES: MATERIAL&FINISH
- HOUSING:HIGH THERMOPLASTIC;COLOR:BEIGE
  - TERMINAL:COPPER ALLOY.t=0.15mm  
PLATING:CONTACT AREA GOLD SEE P/N.  
SOLDER AREA MATTE TIN.(LEAD FREE) 75u" MIN.,  
OVERALL WITH 50~150u"NICKEL UNDER PLATED.
  - SHELL:STAINLESS STEEL t=0.15mm  
PLATING:SOLDER AREA PLATED WITH GOLD FLASH,  
10u"~80u"NICKEL UNDER PLATED
  - SPECIFICATIONS:
    - CURRENT RATING:1A AC,DC
    - VOLTAGE RATING:200V AC,DC
    - WITHSTANDING VOLTAGE:500V AC/MINUTE.
    - INSULATION RESISTANCE:100MΩ MIN.
    - CONTACT RESISTANCE:40mΩ MAX.
    - OPERATING TEMPERATURE:-40°C~+80°C



SCALE 2:1  
SEC. A-A

DESIGN:	Xiping Huang		 广东国连电子有限公司 GUANGDONG GUOLIAN ELECTRONICS CO.,LTD
CHECK:	Ke Tian		
APPROVED:	Youquan Xu		TITLE: LVDS 1.0-30P板上H2.3
DIM	TOL	DIM	TOL
X.	±0.25		
X.X	±0.20	X°	±3.0°
X.XX	±0.15	X.X°	
X.XXX		X.XX°	
		X.XXX°	
PART NO.			1023-30R-GF-R
REV. A	SCALE: N/A	UNIT: mm	SHEET: 1/1

